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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	16
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/zilog/zgp323hep2004c">https://www.e-xfl.com/product-detail/zilog/zgp323hep2004c</a>



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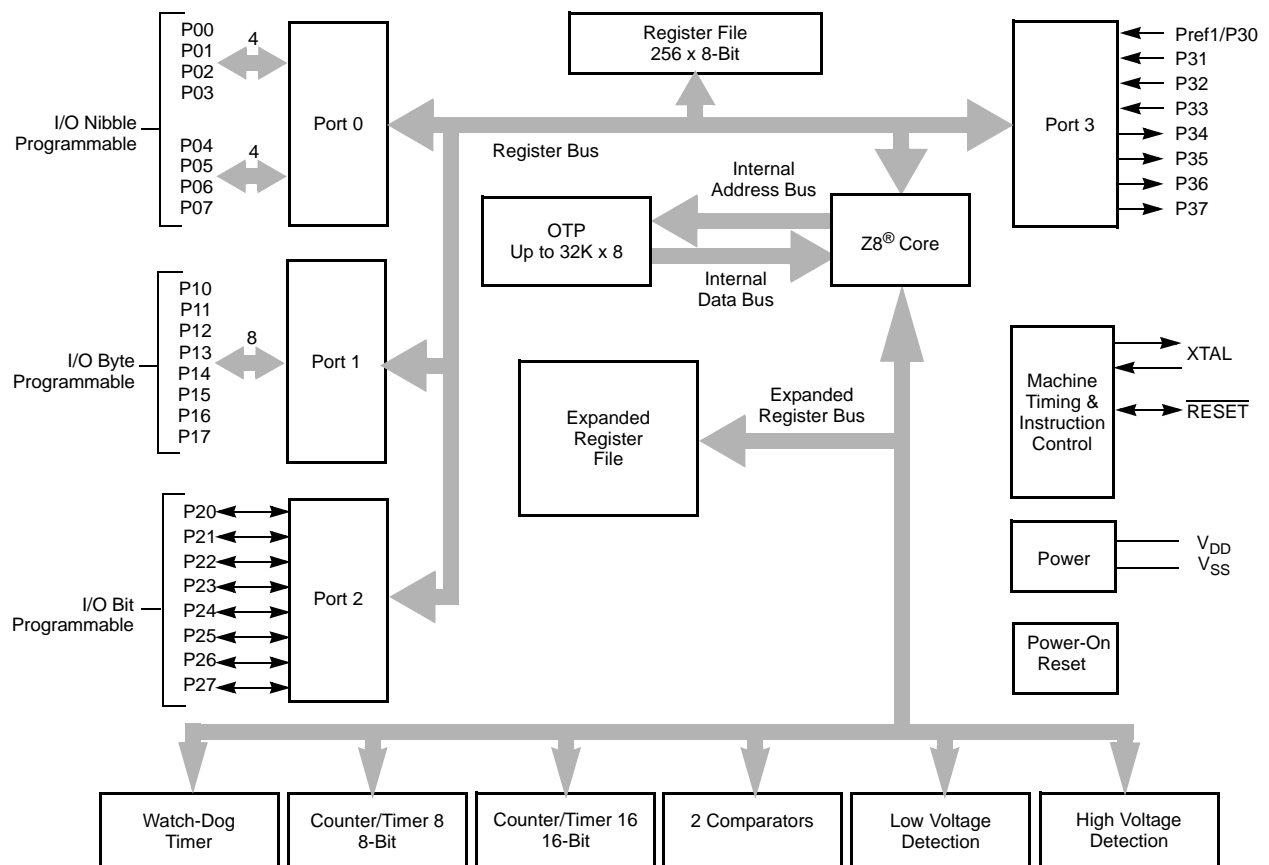
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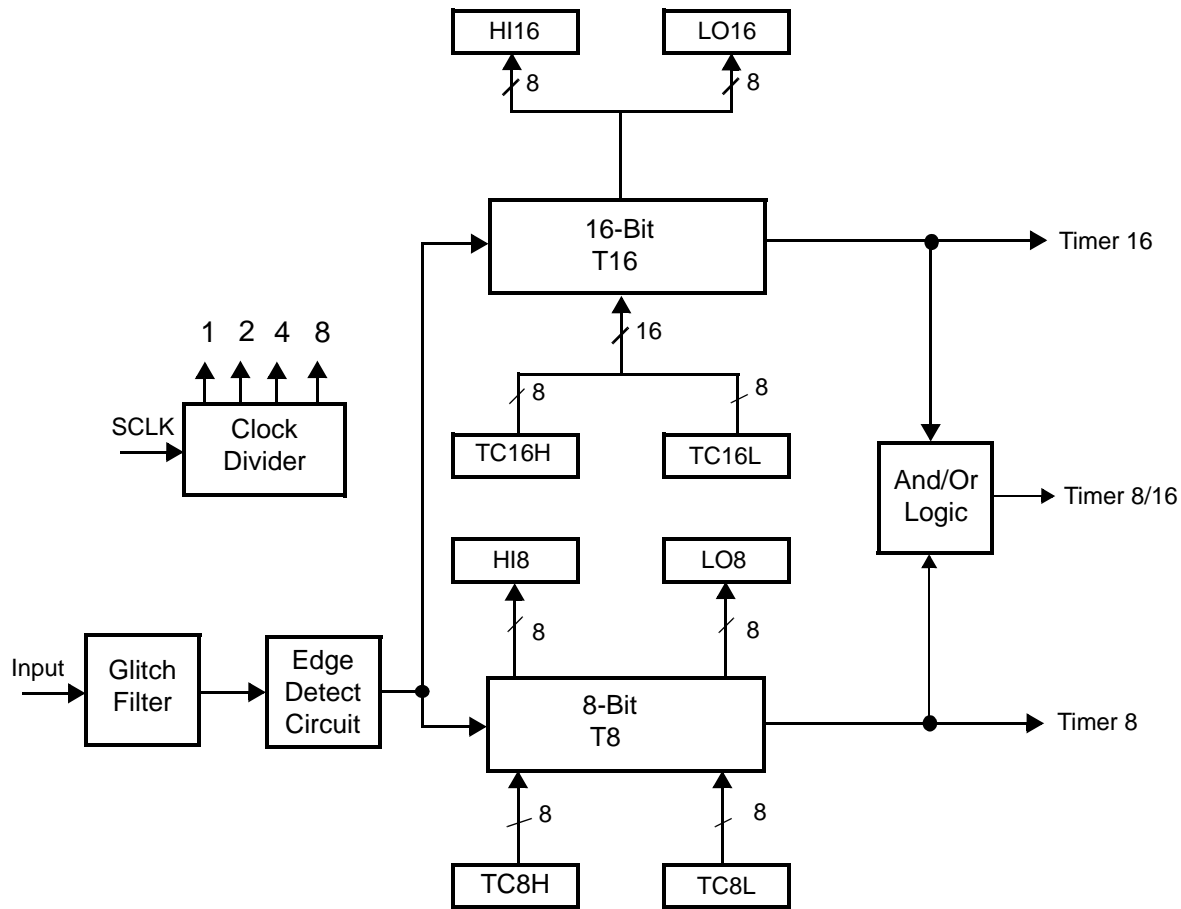
**Table 3. Power Connections**

Connection	Circuit	Device
Power	V <sub>CC</sub>	V <sub>DD</sub>
Ground	GND	V <sub>SS</sub>



Note: Refer to the specific package for available pins.

**Figure 1. Functional Block Diagram**

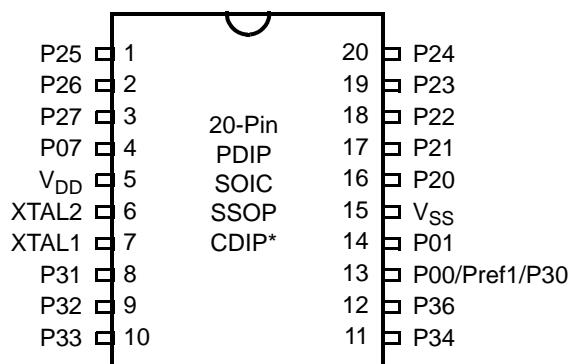


**Figure 2. Counter/Timers Diagram**

## Pin Description

The pin configuration for the 20-pin PDIP/SOIC/SSOP is illustrated in Figure 3 and described in Table 4. The pin configuration for the 28-pin PDIP/SOIC/SSOP are depicted in Figure 4 and described in Table 5. The pin configurations for the 40-pin PDIP and 48-pin SSOP versions are illustrated in Figure 5, Figure 6, and described in Table 6.

For customer engineering code development, a UV eraseable windowed cerdip packaging is offered in 20-pin, 28-pin, and 40-pin configurations. ZiLOG does not recommend nor guarantee these packages for use in production.



**Figure 3. 20-Pin PDIP/SOIC/SSOP/CDIP\* Pin Configuration**

**Table 4. 20-Pin PDIP/SOIC/SSOP/CDIP\* Pin Identification**

Pin #	Symbol	Function	Direction
1–3	P25–P27	Port 2, Bits 5,6,7	Input/Output
4	P07	Port 0, Bit 7	Input/Output
5	V <sub>DD</sub>	Power Supply	
6	XTAL2	Crystal Oscillator Clock	Output
7	XTAL1	Crystal Oscillator Clock	Input
8–10	P31–P33	Port 3, Bits 1,2,3	Input
11,12	P34. P36	Port 3, Bits 4,6	Output
13	P00/Pref1/P30	Port 0, Bit 0/Analog reference input Port 3 Bit 0	Input/Output for P00 Input for Pref1/P30
14	P01	Port 0, Bit 1	Input/Output
15	V <sub>SS</sub>	Ground	
16–20	P20–P24	Port 2, Bits 0,1,2,3,4	Input/Output



**Table 6. 40- and 48-Pin Configuration (Continued)**

40-Pin PDIP #	48-Pin SSOP #	Symbol
33	40	P13
8	9	P14
9	10	P15
12	15	P16
13	16	P17
35	42	P20
36	43	P21
37	44	P22
38	45	P23
39	46	P24
2	2	P25
3	3	P26
4	4	P27
16	19	P31
17	20	P32
18	21	P33
19	22	P34
22	26	P35
24	28	P36
23	27	P37
20	23	NC
40	47	NC
1	1	NC
21	25	RESET
15	18	XTAL1
14	17	XTAL2
11	12, 13	V <sub>DD</sub>
31	24, 37, 38	V <sub>SS</sub>
25	29	Pref1/P30
	48	NC
	6	NC
	14	NC
	30	NC
	36	NC

## Absolute Maximum Ratings

Stresses greater than those listed in Table 8 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

**Table 7. Absolute Maximum Ratings**

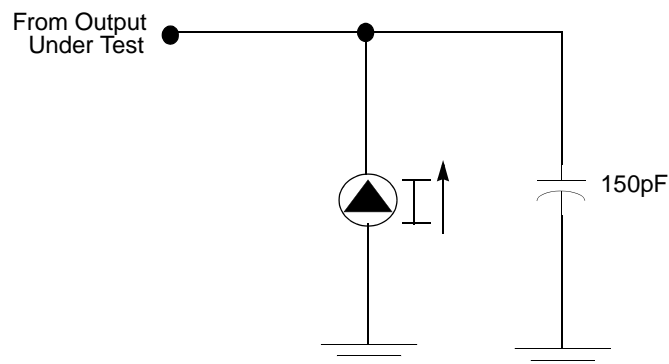
Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	-40	125	° C	1
Storage temperature	-65	+150	° C	
Voltage on any pin with respect to $V_{SS}$	-0.3	7.0	V	2
Voltage on $V_{DD}$ pin with respect to $V_{SS}$	-0.3	7.0	V	
Maximum current on input and/or inactive output pin	-5	+5	$\mu$ A	
Maximum output current from active output pin	-25	+25	mA	
Maximum current into $V_{DD}$ or out of $V_{SS}$		75	mA	

Notes:

1. See Ordering Information.
2. This voltage applies to all pins except the following:  $V_{DD}$ , P32, P33 and RESET.

## Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).



**Figure 7. Test Load Diagram**



**Table 10. GP323HE DC Characteristics (Continued)**

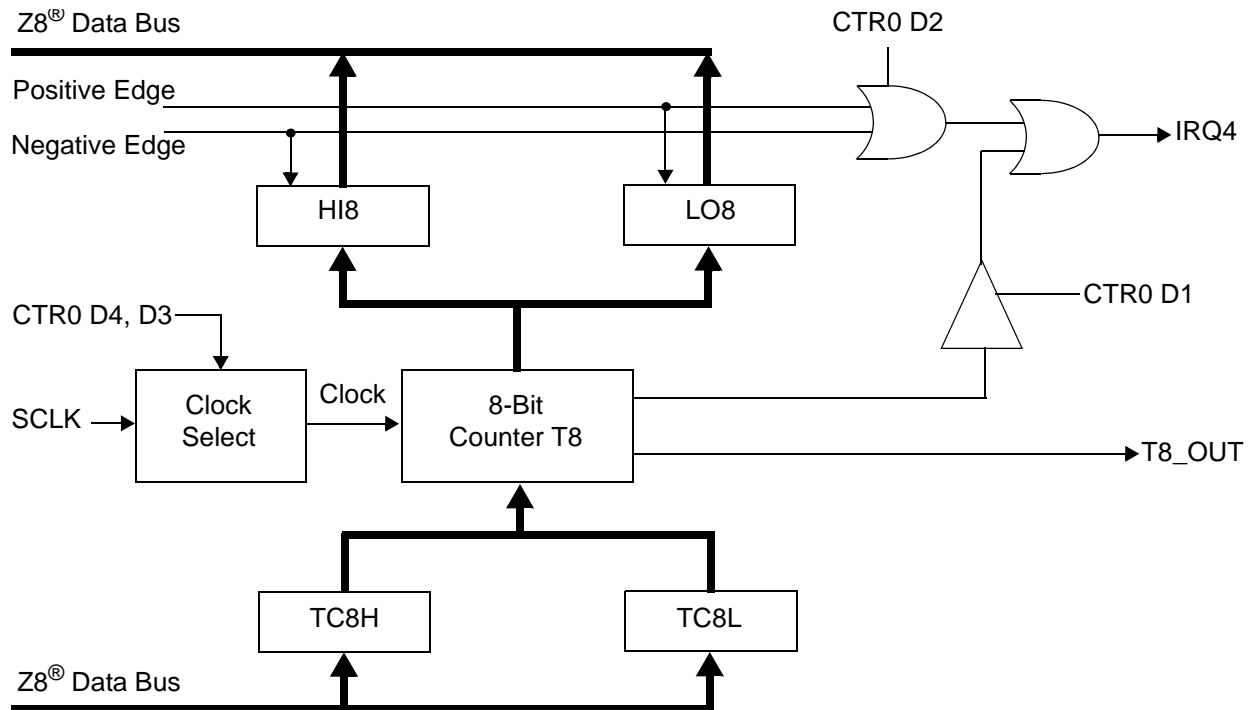
Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = -40°C to +105°C			Units	Conditions	Notes
			Min	Typ(7)	Max			
V <sub>OH2</sub>	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V <sub>CC</sub> -0.8			V	I <sub>OH</sub> = -7mA	
V <sub>OL1</sub>	Output Low Voltage	2.0-5.5			0.4	V	I <sub>OL</sub> = 4.0mA	
V <sub>OL2</sub>	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I <sub>OL</sub> = 10mA	
V <sub>OFFSET</sub>	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V <sub>REF</sub>	Comparator Reference Voltage	2.0-5.5	0		V <sub>DD</sub> -1.75	V		
I <sub>IL</sub>	Input Leakage	2.0-5.5	-1		1	μA	V <sub>IN</sub> = 0V, V <sub>CC</sub> Pull-ups disabled	
R <sub>PU</sub>	Pull-up Resistance	2.0V	200.0		700.0	KΩ	V <sub>IN</sub> = 0V; Pullups selected by mask option	
		3.6V	50.0		300.0	KΩ		
		5.0V	25.0		175.0	KΩ		
I <sub>OL</sub>	Output Leakage	2.0-5.5	-1		1	μA	V <sub>IN</sub> = 0V, V <sub>CC</sub>	
I <sub>CC</sub>	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1, 2
		5.5V		10	15	mA	at 8.0 MHz	1, 2
I <sub>CC1</sub>	Standby Current (HALT Mode)	2.0V		0.5	1.6	mA	V <sub>IN</sub> = 0V, Clock at 8.0MHz	1, 2, 6
		3.6V		0.8	2.0	mA	V <sub>IN</sub> = 0V, Clock at 8.0MHz	1, 2, 6
		5.5V		1.3	3.2	mA	V <sub>IN</sub> = 0V, Clock at 8.0MHz	1, 2, 6
I <sub>CC2</sub>	Standby Current (Stop Mode)	2.0V		1.6	12	μA	V <sub>IN</sub> = 0 V, V <sub>CC</sub> WDT not Running	3
		3.6V		1.8	15	μA	V <sub>IN</sub> = 0 V, V <sub>CC</sub> WDT not Running	3
		5.5V		1.9	18	μA	V <sub>IN</sub> = 0 V, V <sub>CC</sub> WDT not Running	3
		2.0V		5	30	μA	V <sub>IN</sub> = 0 V, V <sub>CC</sub> WDT is Running	3
		3.6V		8	40	μA	V <sub>IN</sub> = 0 V, V <sub>CC</sub> WDT is Running	3
		5.5V		15	60	μA	V <sub>IN</sub> = 0 V, V <sub>CC</sub> WDT is Running	3
I <sub>LV</sub>	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V <sub>BO</sub>	V <sub>CC</sub> Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V <sub>LVD</sub>	V <sub>CC</sub> Low Voltage Detection			2.4		V		
V <sub>HVD</sub>	V <sub>CC</sub> High Voltage Detection			2.7		V		

**Notes:**

1. All outputs unloaded, inputs at rail.
2. CL1 = CL2 = 100 pF.
3. Oscillator stopped.
4. Oscillator stops when V<sub>CC</sub> falls below V<sub>BO</sub> limit.
5. It is strongly recommended to add a filter capacitor (minimum 0.1 μF), physically close to V<sub>CC</sub> and V<sub>SS</sub> pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.
6. Comparator and Timers are on. Interrupt disabled.
7. Typical values shown are at 25 degrees C.



When T8 is enabled, the output T8\_OUT switches to the initial value (CTR1, D1). If the initial value (CTR1, D1) is 0, TC8L is loaded; otherwise, TC8H is loaded into the counter. In SINGLE-PASS Mode (CTR0, D6), T8 counts down to 0 and stops, T8\_OUT toggles, the timeout status bit (CTR0, D5) is set, and a timeout interrupt can be generated if it is enabled (CTR0, D1). In Modulo-N Mode, upon reaching terminal count, T8\_OUT is toggled, but no interrupt is generated. From that point, T8 loads a new count (if the T8\_OUT level now is 0), TC8L is loaded; if it is 1, TC8H is loaded. T8 counts down to 0, toggles T8\_OUT, and sets the timeout status bit (CTR0, D5), thereby generating an interrupt if enabled (CTR0, D1). One cycle is thus completed. T8 then loads from TC8H or TC8L according to the T8\_OUT level and repeats the cycle. See Figure 20.



**Figure 20. 8-Bit Counter/Timer Circuits**

You can modify the values in TC8H or TC8L at any time. The new values take effect when they are loaded.



**Caution:** To ensure known operation do not write these registers at the time the values are to be loaded into the counter/timer. An initial count of 1 is not allowed (a non-function occurs). An initial count of 0 causes TC8 to count from 0 to FFH to FEH.

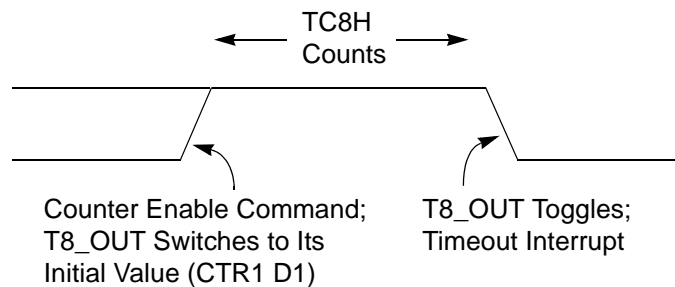
► **Note:** The letter *h* denotes hexadecimal values.

Transition from 0 to FF<sub>h</sub> is not a timeout condition.

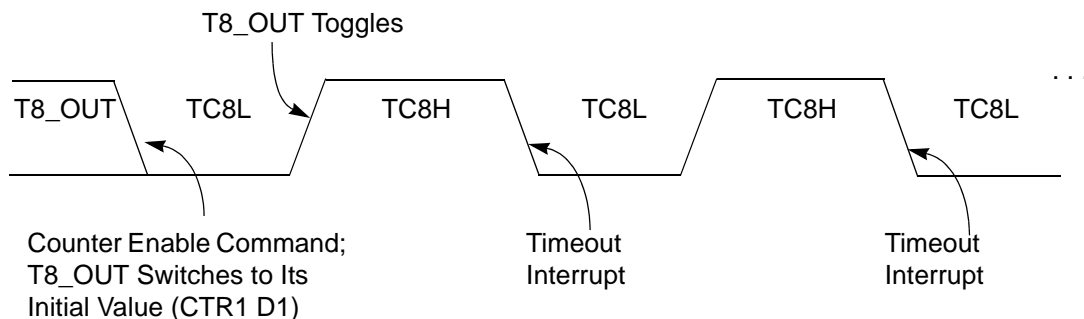


**Caution:** Using the same instructions for stopping the counter/timers and setting the status bits is not recommended.

Two successive commands are necessary. First, the counter/timers must be stopped. Second, the status bits must be reset. These commands are required because it takes one counter/timer clock interval for the initiated event to actually occur. See Figure 21 and Figure 22.



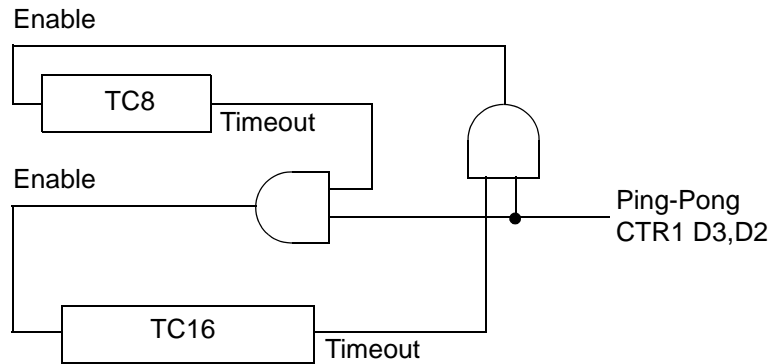
**Figure 21. T8\_OUT in Single-Pass Mode**



**Figure 22. T8\_OUT in Modulo-N Mode**

### T8 Demodulation Mode

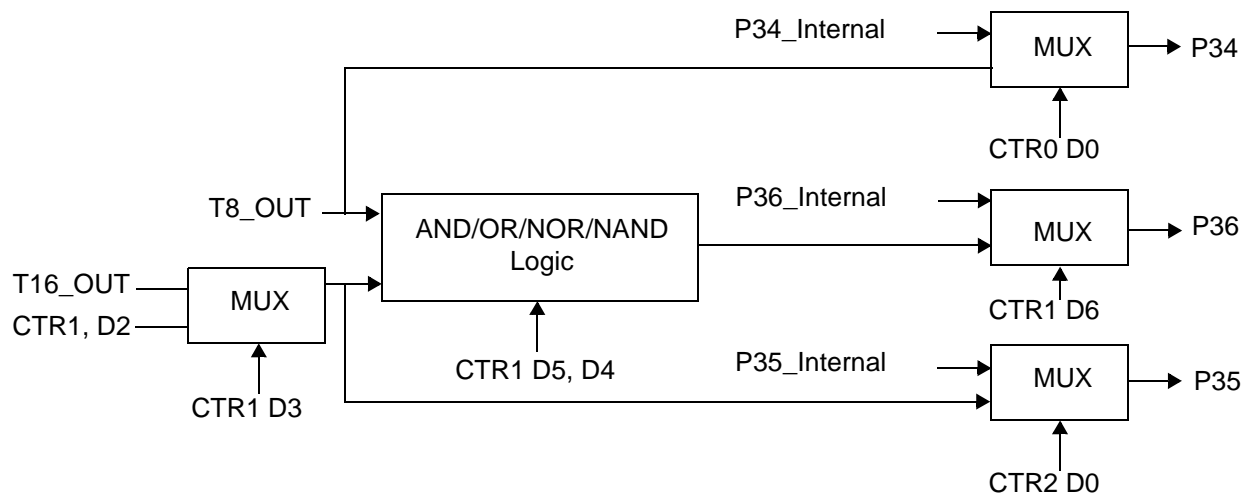
The user must program TC8L and TC8H to FF<sub>h</sub>. After T8 is enabled, when the first edge (rising, falling, or both depending on CTR1, D5; D4) is detected, it starts to count down. When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current value of T8 is complemented and put into one of the capture registers. If it is a positive edge, data is put



**Figure 28. Ping-Pong Mode Diagram**

### Initiating PING-PONG Mode

First, make sure both counter/timers are not running. Set T8 into Single-Pass mode (CTR0, D6), set T16 into SINGLE-PASS mode (CTR2, D6), and set the Ping-Pong mode (CTR1, D2; D3). These instructions can be in random order. Finally, start PING-PONG mode by enabling either T8 (CTR0, D7) or T16 (CTR2, D7). See Figure 29.



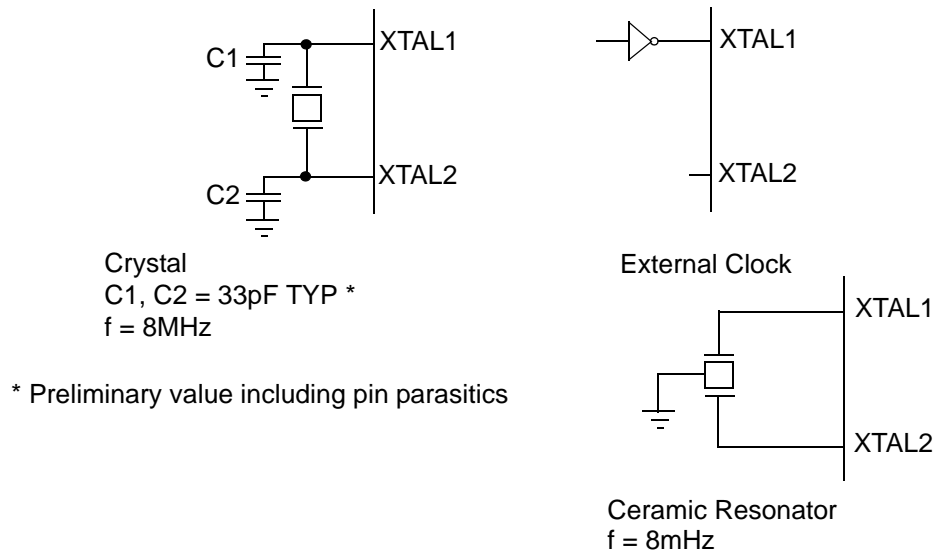
**Figure 29. Output Circuit**

The initial value of T8 or T16 must not be 1. Stopping the timer and restarting the timer reloads the initial value to avoid an unknown previous value.

## Clock

The device's on-chip oscillator has a high-gain, parallel-resonant amplifier, for connection to a crystal or ceramic resonator, or any suitable external clock source (XTAL1 = Input, XTAL2 = Output). The crystal must be AT cut, 1 MHz to 8 MHz maximum, with a series resistance (RS) less than or equal to 100  $\Omega$ . The on-chip oscillator can be driven with a suitable external clock source.

The crystal must be connected across XTAL1 and XTAL2 using the recommended capacitors (capacitance greater than or equal to 22 pF) from each pin to ground.



**Figure 31. Oscillator Configuration**



### Power-On Reset

A timer circuit clocked by a dedicated on-board RC-oscillator is used for the Power-On Reset (POR) timer function. The POR time allows  $V_{DD}$  and the oscillator circuit to stabilize before instruction execution begins.

The POR timer circuit is a one-shot timer triggered by one of three conditions:

- Power Fail to Power OK status, including Waking up from  $V_{BO}$  Standby
- Stop-Mode Recovery (if D5 of SMR = 1)
- WDT Timeout

The POR timer is 2.5 ms minimum. Bit 5 of the Stop-Mode Register determines whether the POR timer is bypassed after Stop-Mode Recovery (typical for external clock).

### HALT Mode

This instruction turns off the internal CPU clock, but not the XTAL oscillation. The counter/timers and external interrupts IRQ0, IRQ1, IRQ2, IRQ3, IRQ4, and IRQ5 remain active. The devices are recovered by interrupts, either externally or internally generated. An interrupt request must be executed (enabled) to exit HALT Mode. After the interrupt service routine, the program continues from the instruction after HALT Mode.

### STOP Mode

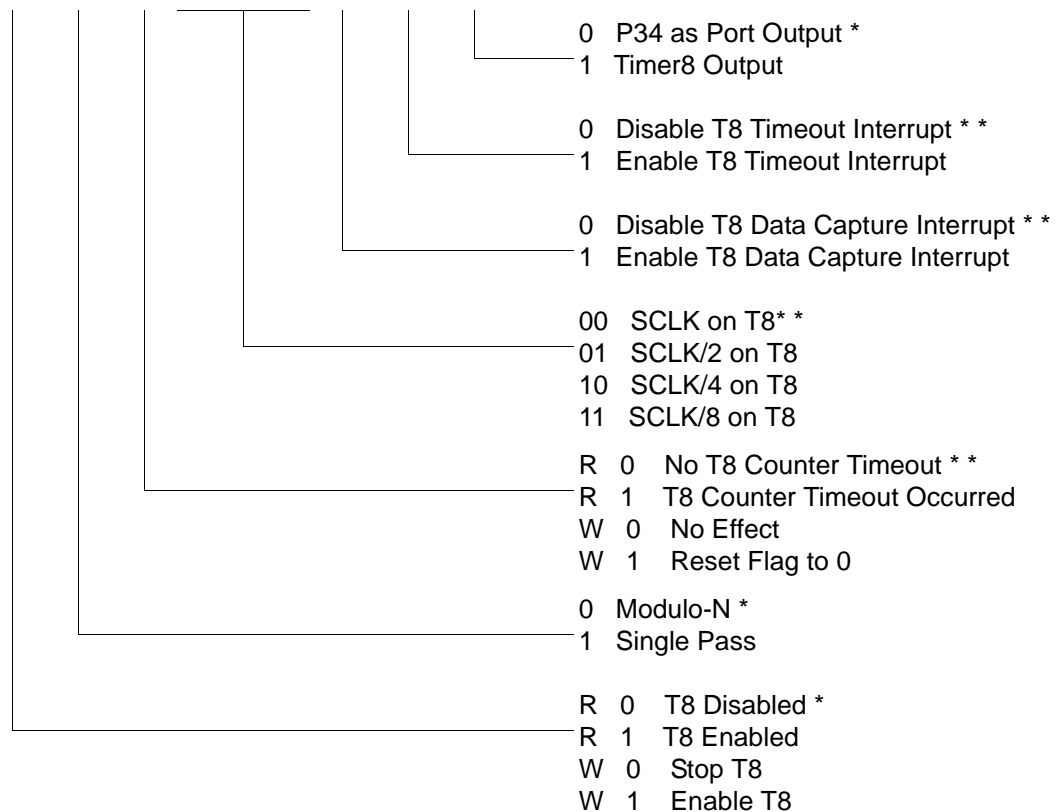
This instruction turns off the internal clock and external crystal oscillation, reducing the standby current to 10  $\mu$ A or less. STOP Mode is terminated only by a reset, such as WDT timeout, POR, SMR or external reset. This condition causes the processor to restart the application program at address 000CH. To enter STOP (or HALT) mode, first flush the instruction pipeline to avoid suspending execution in mid-instruction. Execute a NOP (Opcode = FFH) immediately before the appropriate sleep instruction, as follows:

## Expanded Register File Control Registers (0D)

The expanded register file control registers (0D) are depicted in Figure 39 through Figure 43.

CTR0(0D)00H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



\* Default setting after reset.

\*\* Default setting after Reset.. Not reset with a Stop-Mode recovery.

**Figure 39. TC8 Control Register ((0D)00H: Read/Write Except Where Noted)**

CTR1(0D)01H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

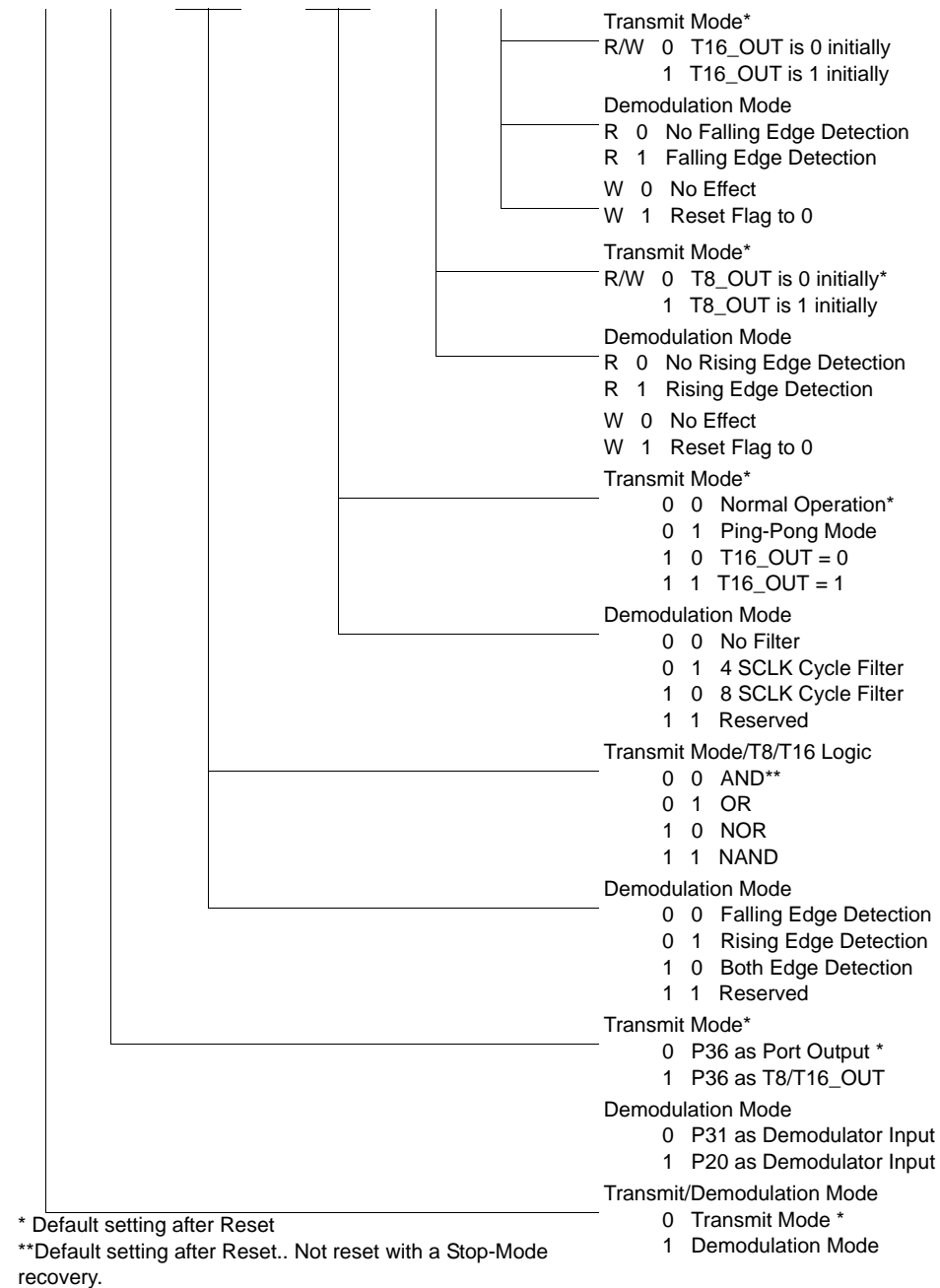
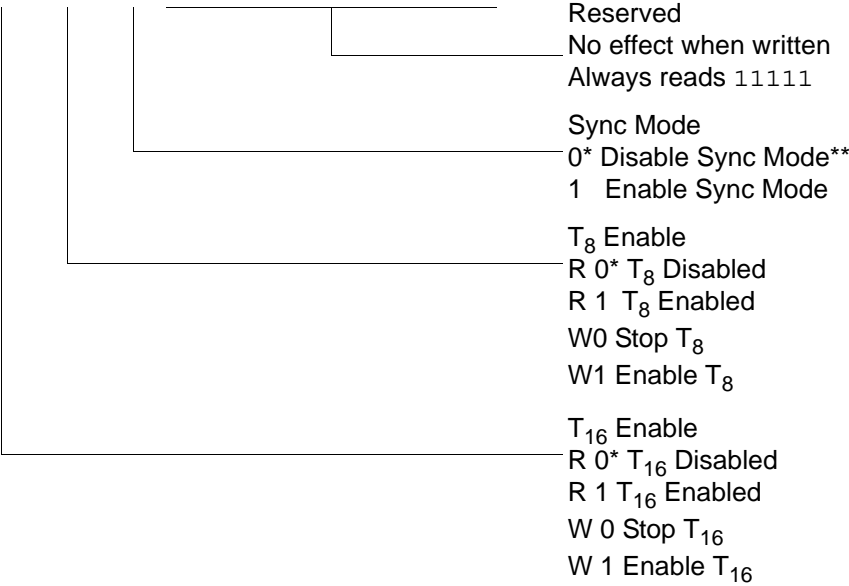


Figure 40. T8 and T16 Common Control Functions ((0D)01H: Read/Write)



CTR3(0D)03H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

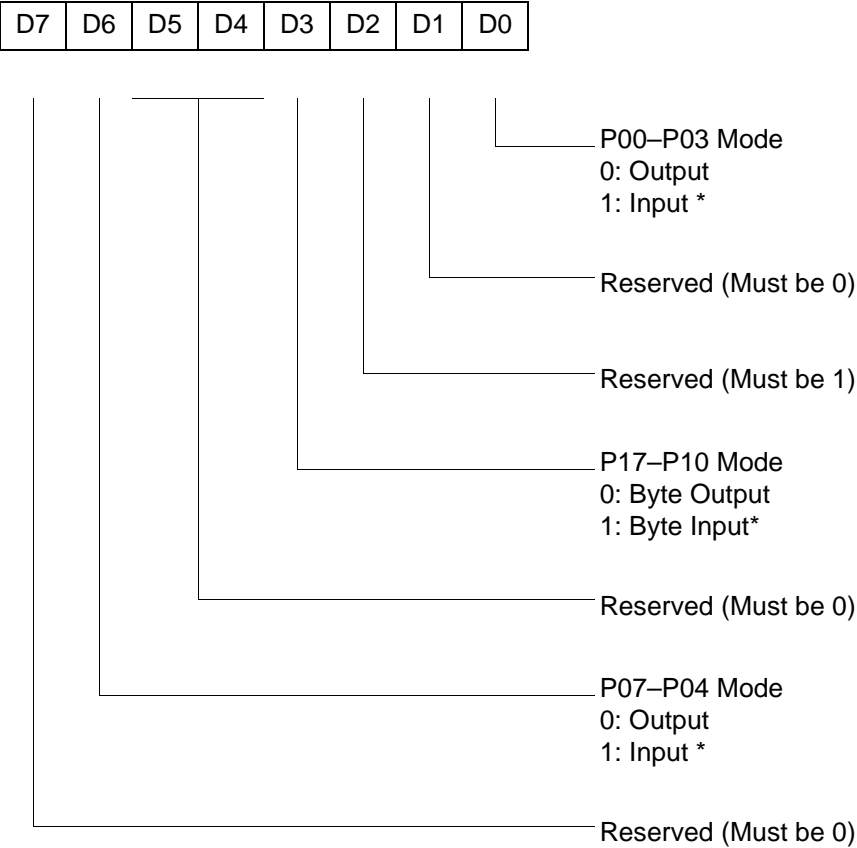


\* Default setting after reset.  
\*\* Default setting after reset. Not reset with a Stop Mode recovery.

Figure 42. T8/T16 Control Register (0D)03H: Read/Write (Except Where Noted)

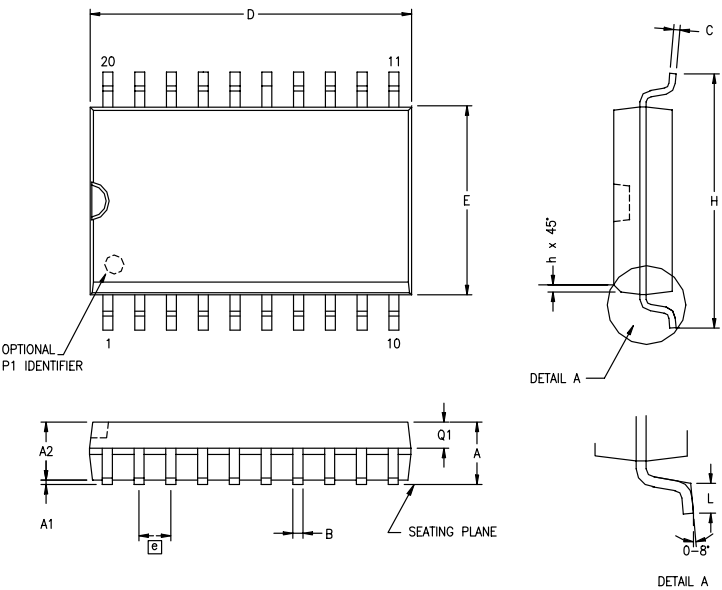


R248 P01M(F8H)



\* Default setting after reset; only P00, P01 and P07 are available on 20-pin configurations.

Figure 50. Port 0 and 1 Mode Register (F8H: Write Only)



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.40	2.65	.094	.104
A1	0.10	0.30	.004	.012
A2	2.24	2.44	.088	.096
B	0.36	0.46	.014	.018
C	0.23	0.30	.009	.012
D	12.60	12.95	.496	.510
E	7.40	7.60	.291	.299
⌀	1.27 BSC		.050 BSC	
H	10.00	10.65	.394	.419
h	0.30	0.40	.012	.016
L	0.60	1.00	.024	.039
Q1	0.97	1.07	.038	.042

CONTROLLING DIMENSIONS : MM  
LEADS ARE COPLANAR WITHIN .004 INCH.

Figure 60. 20-Pin SOIC Package Diagram

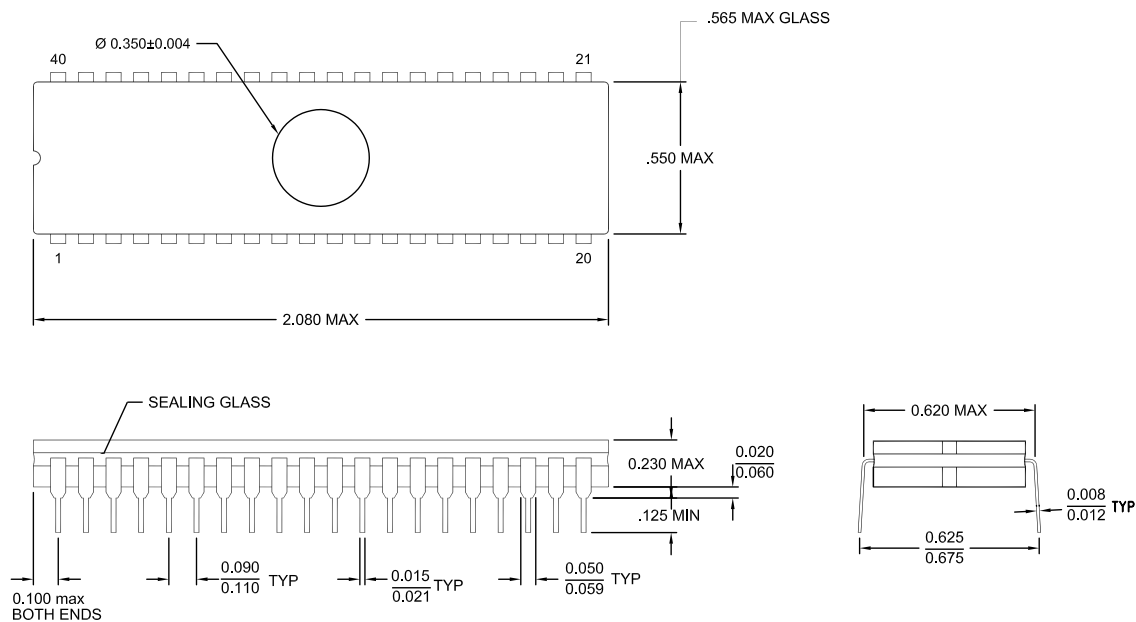
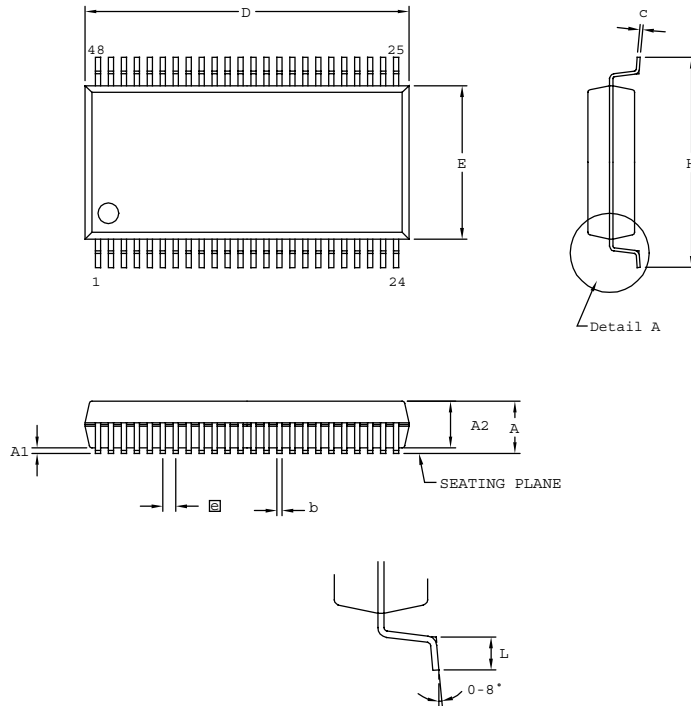


Figure 67. 40-Pin CDIP Package Diagram



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.41	2.79	0.095	0.110
A1	0.23	0.38	0.009	0.015
A2	2.18	2.39	0.086	0.094
b	0.20	0.34	0.008	0.0135
c	0.13	0.25	0.005	0.010
D	15.75	16.00	0.620	0.630
E	7.39	7.59	0.291	0.299
ⓐ	0.635 BSC		0.025 BSC	
H	10.16	10.41	0.400	0.410
L	0.51	1.016	0.020	0.040

CONTROLLING DIMENSIONS : MM  
LEADS ARE COPLANAR WITHIN .004 INCH

**Figure 68. 48-Pin SSOP Package Design**

- **Note:** Check with ZiLOG on the actual bonding diagram and coordinate for chip-on-board assembly.

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